





MYC-YF13X CPU Module Overview



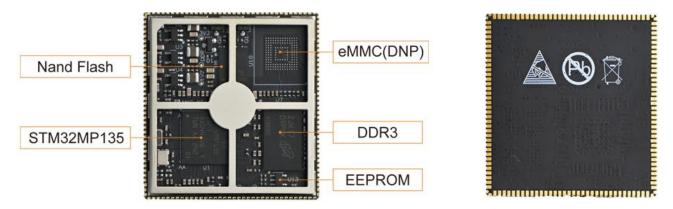


- ✓ 1GHz ST STM32MP135 ARM Cortex-A7 Processor
- ✓ 256/512MB DDR3L, 256MB Nand Flash/4GB eMMC, 32Kbit EEPROM
- ✓ 1.0mm pitch 148-pin Stamp Hole Expansion Interface
- ✓ Supports Running Linux 5.15



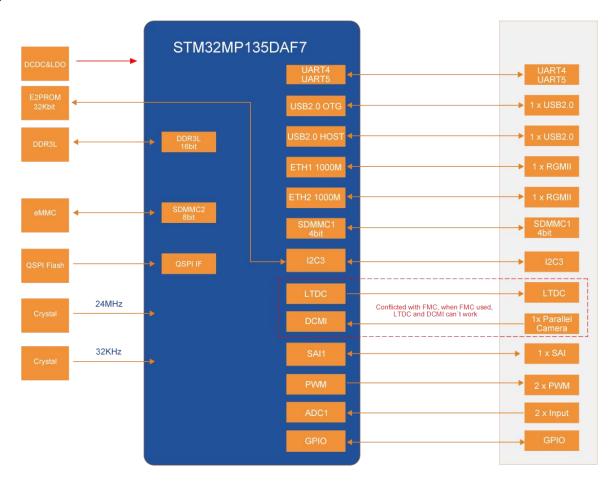


Measuring only 37mm by 39mm, the MYC-YF13X CPU Module is a compact System-on-Module (SoM) based on ST STM32MP135 processor (STM32MP135DAF7) which among the STM32MP1 series processor and features 1GHz single ARM Cortex-A7 core. It has onboard DDR3L, Nand Flash or eMMC, and 32Kbit EEPROM. A variety of peripheral and IO signals are brought out through the 1.0 mm pitch 148-pin stamp-hole (Castellated-Hole) expansion interface. With high reliability, extensive peripheral resources and low cost, the MYC-YF13X can be used in a wide range of applications such as energy power, industrial control, industrial gateway, industrial HMI, and more others.



MYC-YF13X CPU Module Top-view and Bottom-view (delivered with shielding cover installed by default)

The <u>MYC-YF13X CPU Module</u> is capable of running Linux 5.15. MYIR provides image files, kernel and driver source codes, application demos and compilation tools to enable users to start their development rapidly and easily.

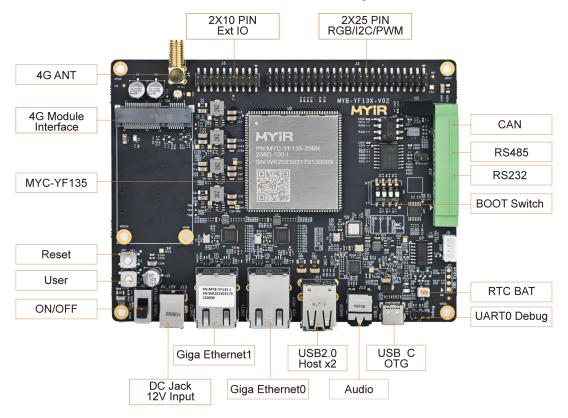


MYC-YF13X CPU Module Function Block Diagram

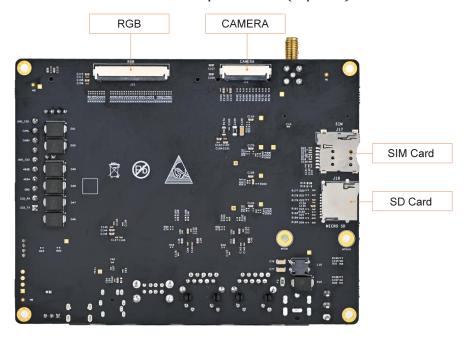




The MYD-YF13X Development Board is provided for evaluating and prototyping based on STM32MP135 series microprocessors. It is built around the MYC-YF13X CPU Module and has brought out a rich set of peripherals and interfaces to the base board including RS232, RS485, two USB 2.0 HOST and one USB 2.0 OTG, two Gigabit Ethernet, CAN, one Micro SD card slot, one USB based Mini-PCIe 4G Module interface with one SIM card holder, LCD interface, Camera interface, Audio input and output as well as two extension headers. It is delivered with Quick Start Guide, one USB to TTL serial cable, one 12V/2A Power adapter and one DC Power jack adapter to help users start up the development right away out-of-the-box. MYIR also offers MY-LCD70TP-C LCD Module, MY-CAM011B Camera Module and MY-RGB2HDMI Module as the options for the board.



MYD-YF13X Development Board (Top-view)



MYD-YF13X Development Board (Bottom-view)





Hardware Specification

The MYC-YF13X CPU Module is using 11 x 11mm, 0.5 mm ball pitch, 320ball TFBGA package, 1GHz ST STM32MP135DAF7 MPU which belongs to the ST STM32MP135 product line and features a single Arm Cortex-A7 core running up to 1GHz, a dedicated LCD-TFT parallel display interface, a 16-bit parallel camera and dual Ethernet ports to offer cost- & energy-efficient processing capabilities. The STM32MP135 line is available in 3 different packages for a cost-efficient PCB architecture.

Feature	Description		
CPU	32-bit Arm® Cortex®-A7 1GHz		
External Storage	up to LPDDR2/LPDDR3-1066 16-bit		
	up to DDR3/DDR3L-1066 16-bit		
	Dual Quad-SPI memory interface		
	16-bit data bus: parallel interface to connect external ICs and SLC NAND memories with		
	up to 8-bit ECC		
	Video Encoder / Decoder support		
	up to WXGA (1366 × 768) @60 fps or up to Full HD (1920 x 1080) @ 30 fps		
Video Engine	pixel clock up to 90 MHz		
	two layers (incl. 1 secured) with programmable color		
	2 ADCs with 12-bit max. resolution up to 5 Msps		
Analog	1 x temperature sensor		
Peripheral	1 x digital filter for sigma-delta modulator (DFSDM) with 4 channels and 2 filters		
	Internal or external ADC reference VREF+		
	Internal oscillators: 64 MHz HSI oscillator, 4 MHz CSI oscillator, 32 kHz LSI oscillator		
RTC	External oscillators: 8-48 MHz HSE oscillator, 32.768 kHz LSE oscillator		
	4 x PLLs with fractional mode		
	56 physical channels in total		
Controller	1 x high-speed general-purpose master direct memory access controller (MDMA)		
Controller	3 x dual-port DMAs with FIFO and request router capabilities for optimal peripheral		
	management		
Safety Engine	TrustZone® peripherals, 12 x tamper pins including 5 x active tampers		
Safety Eligilie	Temperature, voltage, frequency and 32 kHz monitoring		
	5 x I2C FM+ (1 Mbit/s, SMBus/PMBus)		
	4 x UART + 4 x USART (12.5 Mbit/s, ISO7816 interface, LIN, IrDA, SPI slave)		
	5 x SPI (50 Mbit/s, including 4 with full-duplex I 2S audio class accuracy via internal		
	audio PLL or external clock)		
	2 x SAI (stereo audio: I2S, PDM, SPDIF Tx)		
	SPDIF Rx with 4 inputs		
Connection	2 x SDMMC up to 8 bits (SD/eMMC/SDIO)		
	2 x CAN controllers supporting CAN FD protocol		
	2 x USB 2.0 high-speed Host – or 1 × USB 2.0 high-speed Host +1 × USB 2.0 high-speed		
	OTG simultaneously		
	2 x Ethernet MAC/GMAC – IEEE 1588v2 hardware, MII/RMII/RGMII		
	8- to 16-bit camera interface, 3 Mpix @30 fps or 5Mpix @15 fps incolor or monochrome		
	with pixel clock @120 MHz (max freq)		
Packaging	BGA 320 balls, 11 mm x 11 mm size,0.5 mm ball pitch		

STM32MP135 Processor Resources





Features



All security features activated.

Note: Packages can support low-cost PCB down to a 4-layer PTH



STM32MP135 Block Diagram



Mechanical Parameters

Dimensions: 37mm x 39mmPCB Layers: 10-layer design

• Power supply: +5V/1A

• Working temperature: -40~85 Celsius (industrial grade)

Processor

• Up to 1GHz ST STM32MP135 ARM Cortex-A7 processor (STM32MP135DAF7)

Memory

256/512MB DDR3L

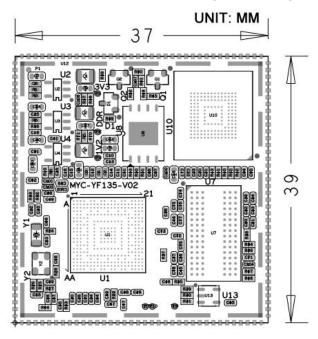
• 256MB Nand FLASH/4GB eMMC

32Kbit EEPROM

Peripherals and Signals Routed to Pins

- 1.0mm pitch 148-pin Stamp Hole Expansion Interface
 - 2 x RGMII
 - 2 x USB2.0
 - -8 x UART
 - 2 x SCI
 - 2 x CAN FD
 - 4 x I2S
 - 5 x I2C
 - 2 x ADC
 - 1 x RGB
 - 1 x Parallel Camera
 - 2 x SAI
 - Up to 108 GPIOs

Note: the peripheral signals brought out to the expansion interface are listed in maximum number. Some signals are reused. Please refer to the processor datasheet and the CPU Module pinout description file.



MYC-YF13X Dimensions Chart





Software Features

The MYC-YF13X CPU Module supports Linux and comes with software packages. The kernel and many peripheral drivers are available in source code to assist clients expedite their ideas. The following are a summary of the software features:

Item	Feature	Description	Source Code
Bootstrap program	Tf-a	First boot program tf-a-STM32MP-2.6	YES
Bootloader	U-boot	Second boot program uboot_2021.10	YES
Linux kernel	Linux 5.15	Customized base on official kernel_5.15.67 version	YES
Device driver	USB Host	USB Host driver	YES
	USB OTG	USB OTG driver	YES
	I2C	I2C driver	YES
	SPI	SPI driver	YES
	Ethernet	YT8521SH driver	YES
	SDHI	eMMC/SD card driver	YES
	LVDS	LCD driver	YES
	4G	4G driver	YES
	PWM	PWM control	YES
	ADC	ADC driver	YES
	RTC	RTC driver	YES
	GPIO	General GPIO driver	YES
	UART	RS232/TTL driver	YES
	CAN	CAN driver	YES
	RS485	RS485 driver	YES
Test .	myir-image-core	image without GUI interface built with Yocto	YES
File system	myir-image-full	full-featured image built with Yocto	YES

MYC-YF13X Software Features



Order Information

Product Item	Part No.	Packing List	
MYC-YF13X	MYC-YF135-256N256D-100-I		
CPU Module	MYC-YF135-4E512D-100-I	✓ One MYC-YF13X CPU Module	
MYD-YF13X	MYD-YF135-256N256D-100-I	 ✓ One MYD-YF13X Development Board (including MYC-YF13X CPU Module) ✓ One USB to UART Debug cable 	
Development Board	MYD-YF135-4E512D-100-I	 ✓ One 12V/2A Power adapter ✓ One DC Power jack adapter ✓ One Quick Start Guide 	
MY-LCD70TP-C 7 inch LCD Module	MY-TFT070CV2	Add-on Options	
MY-CAM011B BUS Camera Module	MY-CAM011B	✓ MY-TFT070CV2 LCD Module ✓ MY-CAM011B BUS Camera Module	
MY-RGB2HDMI RGB-to-HDMI Module	MY-RGB2HDMI	✓ MY-RGB2HDMI	



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